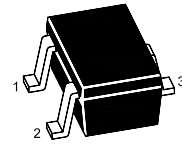
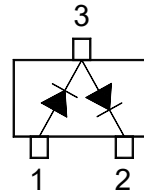


BAV199W-AH

Silicon Epitaxial Planar Switching Diode

Feature

- AEC-Q101 Qualified
- Very low leakage current
- Medium speed switching times
- Series pair configuration
- Halogen and Antimony Free(HAF), RoHS compliant



SOT-323 Plastic Package

Applications

- For low leakage current

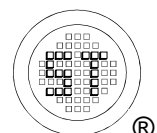
Absolute Maximum Ratings ($T_a = 25^\circ\text{C}$)

Parameter	Symbol	Value	Unit
Peak Repetitive Reverse Voltage	V_{RRM}	85	V
Continuous Reverse Voltage	V_R	85	V
Continuous Forward Current	I_F	160 140	mA
Repetitive Peak Forward Current	I_{FRM}	500	mA
Non-Repetitive Peak Forward Surge Current	I_{FSM}	4 1 0.5	A
Power Dissipation	P_{tot}	250	mW
Operating and Storage Temperature Range	T_j, T_{stg}	- 65 to + 150	$^\circ\text{C}$

Thermal Characteristics

Parameter	Symbol	Max.	Unit
Thermal Resistance from Junction to Ambient ¹⁾	$R_{\theta JA}$	500	$^\circ\text{C/W}$

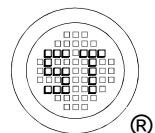
¹⁾ Device mounted on FR-4 substrate PC board, 2oz copper, with minimum recommended pad layout.



BAV199W-AH

Characteristics at $T_a = 25^\circ\text{C}$

Parameter	Symbol	Min.	Max.	Unit
Reverse Breakdown Voltage at $I_R = 100 \mu\text{A}$	$V_{(BR)R}$	85	-	V
Forward Voltage at $I_F = 1 \text{ mA}$ at $I_F = 10 \text{ mA}$ at $I_F = 50 \text{ mA}$ at $I_F = 150 \text{ mA}$	V_F	- - - -	0.9 1 1.1 1.25	V
Reverse Current at $V_R = 75 \text{ V}$ at $V_R = 75 \text{ V}, T_j = 150^\circ\text{C}$	I_R	- -	5 80	nA
Total Capacitance at $V_R = 0, f = 1 \text{ MHz}$	C_T	-	2	pF
Reverse Recovery Time at $I_F = 10 \text{ mA}, V_R = 6 \text{ V}, I_{rr} = 0.1 \times I_R, R_L = 100 \Omega$	t_{rr}	-	3	μs



Electrical Characteristics Curves

Fig 1. Power Derating Curve

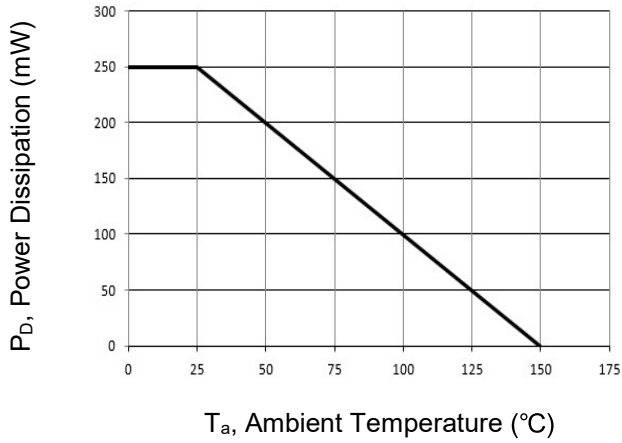


Fig 2. Capacitance Characteristics Curve

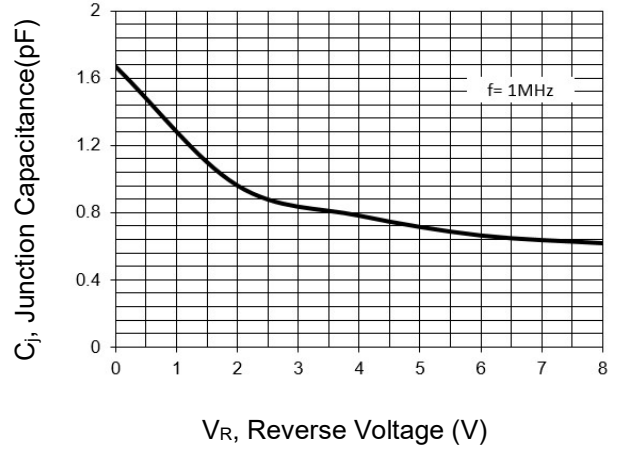


Fig 3. Reverse Characteristics Curve

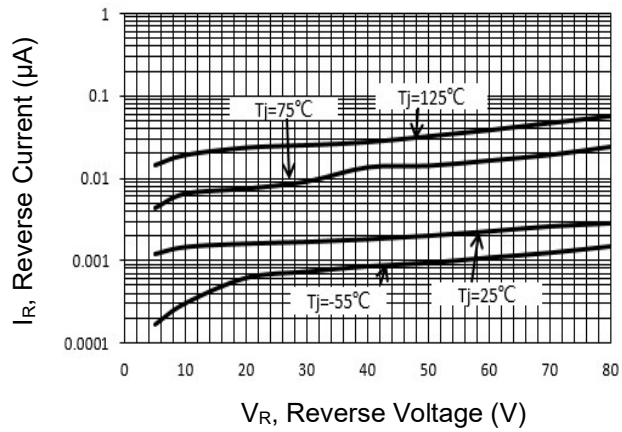
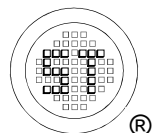
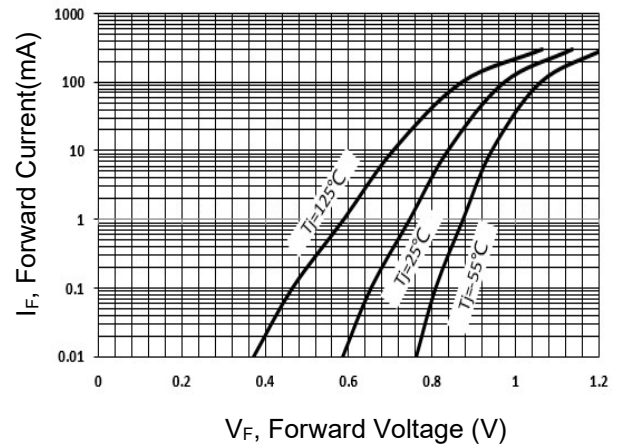


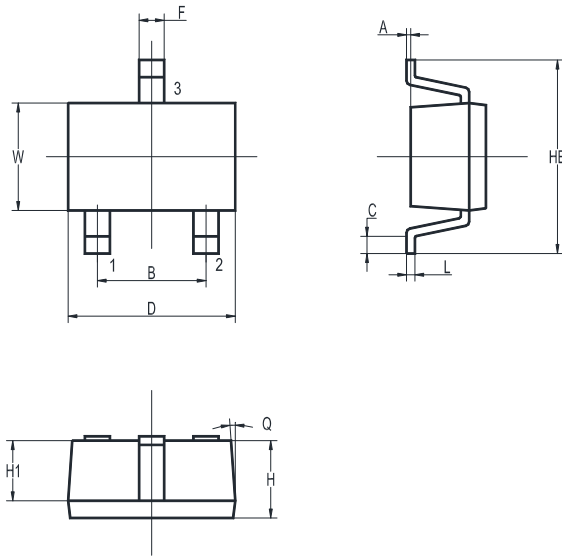
Fig 4. Forward Characteristics Curve



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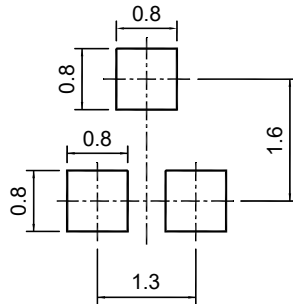
Package Outline Dimensions (Units: mm)

SOT-323



UNIT	A	B	C	D	H	H1	HE	F	L	W	Q
mm	0.1 MAX.	1.4 1.2	0.2 MIN.	2.1 1.9	1.0 0.8	0.7 TYP.	2.4 2.0	0.35 0.25	0.15 0.05	1.35 1.15	5° MAX.

Recommended Soldering Footprint



Packing information

Package	Tape Width (mm)	Pitch		Reel Size		Per Reel Packing Quantity
		mm	inch	mm	inch	
SOT-323	8	4 ± 0.1	0.157 ± 0.004	178	7	3,000

Marking information

- " JY " = Part No.
 - " • " = HAF (Halogen and Antimony Free)
 - " YM " = Date Code Marking
 - " Y " = Year
 - " M " = Month
- Font type: Arial

